

April 2009

FGH60N60SFD 600V, 60A Field Stop IGBT

Features

- · High current capability
- Low saturation voltage: V_{CE(sat)} =2.3V @ I_C = 60A
- High input impedance
- Fast switching
- RoHS compliant

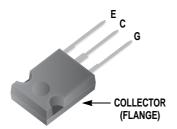
Applications

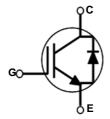
• Induction Heating, UPS, SMPS, PFC



General Description

Using Novel Field Stop IGBT Technology, Fairchild's new series of Field Stop IGBTs offer the optimum performance for Induction Heating, UPS, SMPS and PFC applications where low conduction and switching losses are essential.





Absolute Maximum Ratings

Symbol	Description		Ratings	Units	
V _{CES}	Collector to Emitter Voltage		600	V	
V _{GES}	Gate to Emitter Voltage		± 20	V	
I _C	Collector Current	$@ T_C = 25^{\circ}C$	120	А	
·C	Collector Current	$^{\circ}$ T _C = 100 $^{\circ}$ C	60	А	
I _{CM (1)}	Pulsed Collector Current	@ T _C = 25°C	180	А	
P _D	Maximum Power Dissipation	$@ T_C = 25^{\circ}C$	378	W	
טי	Maximum Power Dissipation	$@ T_C = 100^{\circ}C$	151	W	
T _J	Operating Junction Temperature		-55 to +150	°C	
T _{stg}	Storage Temperature Range		-55 to +150	°C	
T _L	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes:
1: Repetitive test, Pulse width limited by max. juntion temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units	
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction to Case	-	0.33	°C/W	
$R_{\theta JC}(Diode)$	Thermal Resistance, Junction to Case	1.1	°C/W		
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W	

Package Marking and Ordering Information

Device Marking	Device	Package	Packaging Type	Qty per Tube	Max Qty per Box
FGH60N60SFD	FGH60N60SFDTU	TO-247	Tube	30ea	-

Electrical Characteristics of the IGBT $T_C = 25$ °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Charac	teristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250\mu A$	600	-	-	V
$\frac{\Delta BV_{CES}}{\Delta T_J}$	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250\mu A$	-	0.4	-	V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$	-	-	250	μА
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$	-	-	±400	nA
On Charac	teristics					
V _{GE(th)}	G-E Threshold Voltage	$I_{C} = 250 \mu A, V_{CE} = V_{GE}$	4.0	5.0	6.5	V
OL(III)		I _C = 60A, V _{GE} = 15V	-	2.3	2.9	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 60A, V _{GE} = 15V, T _C = 125°C	-	2.5	-	V
Dynamic C	haracteristics			,	•	
C _{ies}	Input Capacitance		-	2820	-	pF
C _{oes}	Output Capacitance	$V_{CE} = 30V_{,} V_{GE} = 0V_{,}$ f = 1MHz	-	350	-	pF
C _{res}	Reverse Transfer Capacitance	- 1 - 11VII 12	-	140	-	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time		-	22	-	ns
t _r	Rise Time	$V_{CC} = 400V, I_{C} = 60A,$	-	42	-	ns
t _{d(off)}	Turn-Off Delay Time		-	134	-	ns
t _f	Fall Time	$R_G = 5\Omega$, $V_{GE} = 15V$,	-	31	62	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 25°C	-	1.79	-	mJ
E _{off}	Turn-Off Switching Loss		-	0.67	-	mJ
E _{ts}	Total Switching Loss		-	2.46	-	mJ
t _{d(on)}	Turn-On Delay Time		-	22	-	ns
t _r	Rise Time		-	44	-	ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 400V, I_{C} = 60A,$	-	144	-	ns
t _f	Fall Time	$R_G = 5\Omega$, $V_{GE} = 15V$,	-	43	-	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 125°C	-	1.88	-	mJ
E _{off}	Turn-Off Switching Loss		-	1.0	-	mJ
E _{ts}	Total Switching Loss		-	2.88	-	mJ
Qg	Total Gate Charge		-	198	-	nC
Q _{ge}	Gate to Emitter Charge	$V_{CE} = 400V, I_{C} = 60A,$ $V_{GF} = 15V$	_	22		nC
Q _{gc}	Gate to Collector Charge	*GE = 10 V	-	106	-	nC

Electrical Characteristics of the Diode $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Units
V _{FM} Diode Forward Voltage	Diode Forward Voltage	I _E = 30A	$T_C = 25^{\circ}C$	-	2.0	2.6	V
	1 - 00/1	$T_{\rm C} = 125^{\rm o}{\rm C}$	-	1.8	-]	
t _{rr}	Diode Reverse Recovery Time Diode Reverse Recovery Charge	lea = 30A dlea/dt = 200A/us	$T_C = 25^{\circ}C$	-	47	-	ns
11			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	179	-]
Q _{rr}			$T_C = 25^{\circ}C$	-	83	-	nC
	2 ious ristores risostery change		$T_{\rm C} = 125^{\rm o}{\rm C}$	-	567	-]

Figure 1. Typical Output Characteristics

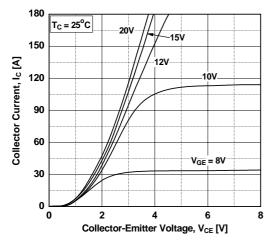


Figure 3. Typical Saturation Voltage Characteristics

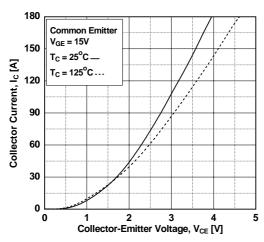


Figure 5. Saturation Voltage vs. Case
Temperature at Variant Current Level

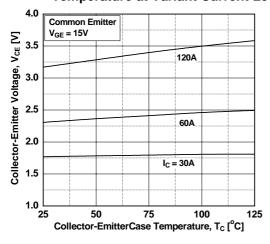


Figure 2. Typical Output Characteristics

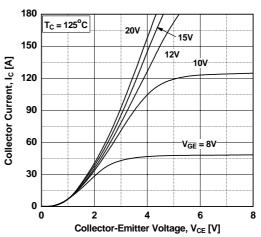


Figure 4. Transfer Characteristics

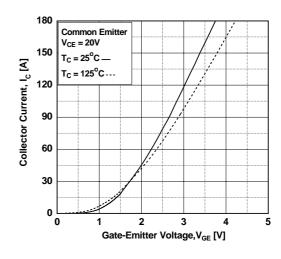


Figure 6. Saturation Voltage vs. V_{GE}

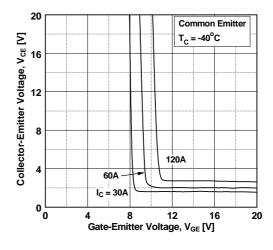


Figure 7. Saturation Voltage vs. V_{GE}

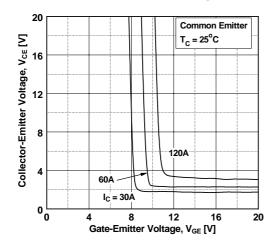


Figure 9. Capacitance Characteristics

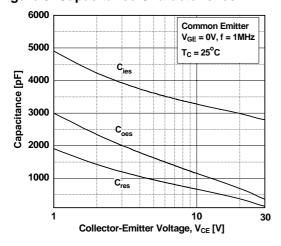


Figure 11. SOA Characteristics

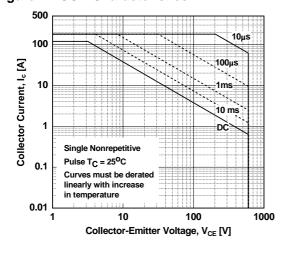


Figure 8. Saturation Voltage vs. V_{GE}

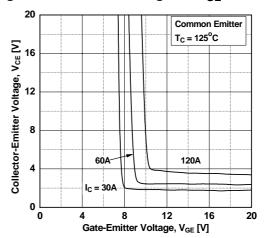


Figure 10. Gate charge Characteristics

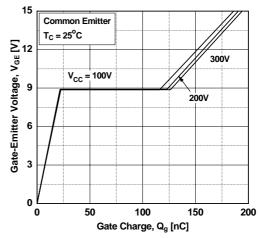


Figure 12. Turn off Switching SOA Characteristics

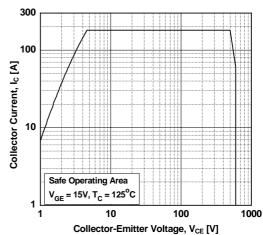


Figure 13. Turn-on Characteristics vs.
Gate Resistance

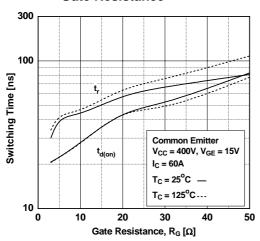


Figure 15. Turn-on Characteristics vs. Collector Current

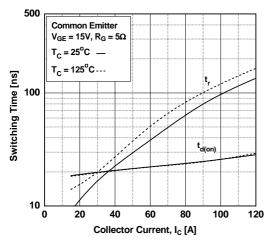


Figure 17. Switching Loss vs Gate Resistance

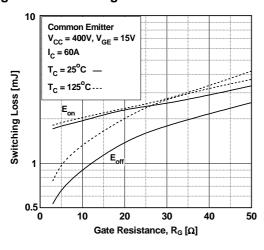


Figure 14. Turn-off Characteristics vs.
Gate Resistance

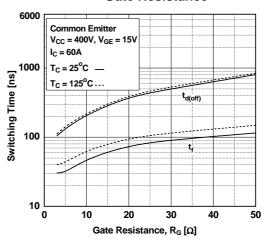


Figure 16. Turn-off Characteristics vs. Collector Current

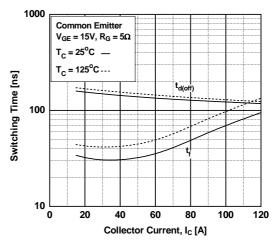


Figure 18. Switching Loss vs Collector Current

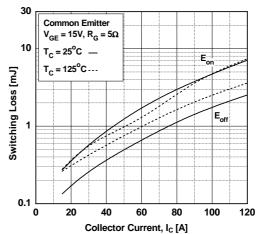


Figure 19. Forward Characteristics

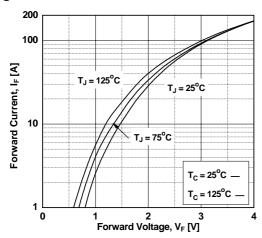


Figure 20. Reverse Current

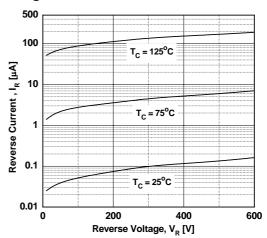


Figure 21. Stored Charge

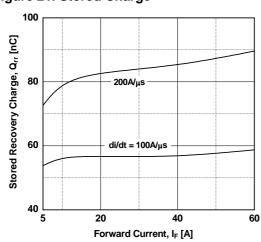


Figure 22. Reverse Recovery Time

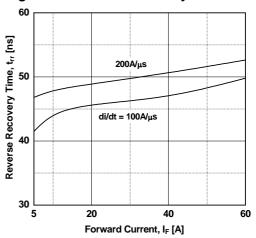
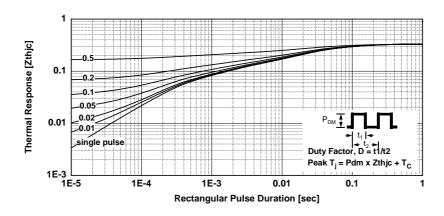
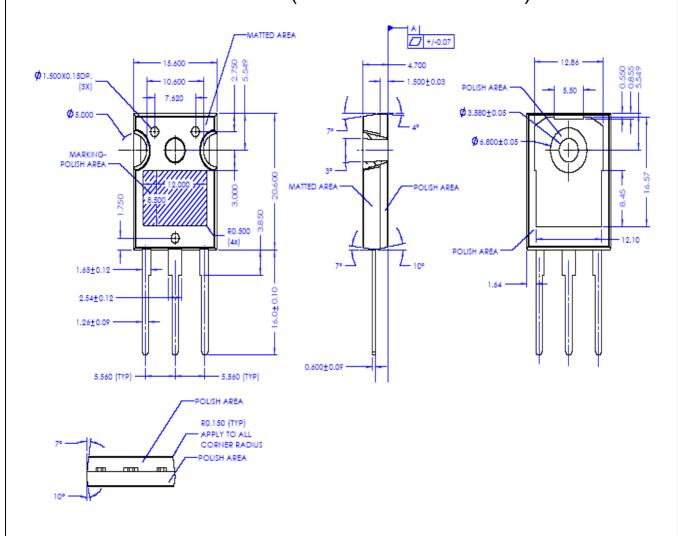


Figure 23. Transient Thermal Impedance of IGBT



Mechanical Dimensions

TO-247AB (FKS PKG CODE 001)



Dimensions in Millimeters





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

Auto-SPM™ F-PFS™ Build it Now™ FRFET®

CorePLUS™ Global Power Resource SM

CorePOWER™ Green FPS™

MicroFET™
MicroPak™
MillerDrive™
MillerDrive™
MotionMax™
Fairchild Semiconductor®
FACT Quiet Series™
FACT Quiet Series™
OPTOLOGIC®
FACT®
OPTOPLANAR®

FAST[®]
FastvCore[™]
FETBench™

FETBench™ PDP SPM™
FlashWriter®* Power-SPM™
FPS™

PowerTrench[®] PowerXS™

Programmable Active Droop™

QFĒT[®]
QS™
Quiet Series™
RapidConfigure™

○_{TM}

Saving our world, 1mW/W/kW at a time™ SmartMax™

SMART START™
SPM®
STEALTH™
SuperFET™
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8
SuperMOS™
SyncFET™

SyncFET™
Sync-Lock™
SYSTEM®*

The Power Franchise® the power Franchise
TinyBoost™
TinyBuck™
TinyLogic®
TINYOPTO™
TinyPower™
TinyPWM™
TinyPWM™
TinyWire™
TriFault Detect™
TRUECURRENT™*

µSerDes™

VERTORS

UHC®

Ultra FRFET™

VCX™

VisualMax™

XS™

DISCL AIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein

- Life support devices or systems are devices or systems which, (a) are
 intended for surgical implant into the body or (b) support or sustain life,
 and (c) whose failure to perform when properly used in accordance
 with instructions for use provided in the labeling, can be reasonably
 expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification Product Status		Definition		
Advance Information Formative / In Design		Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed Full Production		Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

Rev. I40

^{*} Trademarks of System General Corporation, used under license by Fairchild Semiconductor.